



PATENT

Election
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2/21/03

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Kinsman et al.

Serial No.: 09/917,127

Filed: July 27, 2001

For: METHOD FOR FABRICATING A
CHIP SCALE PACKAGE USING WAFER
LEVEL PROCESSING AND DEVICES
RESULTING THEREFROM

Confirmation No.: 3326

Examiner: M. Trinh

Group Art Unit: 2822

Attorney Docket No.: 2269-3572.1US
(97-1243.01/US)

CERTIFICATE OF MAILING

I hereby certify that this correspondence along with any attachments referred to or identified as being attached or enclosed is being deposited with the United States Postal Service as First Class Mail on the date of deposit shown below with sufficient postage and in an envelope addressed to the Commissioner for Patents, Washington, D.C. 20231.

2/7/03
Date

Signature

Leah J. Barrow
Name (Type/Print)

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FEB 14 2003
TECHNOLOGY CENTER 2800

RESPONSE TO ELECTION OF SPECIES REQUIREMENT

Box Non-Fee Amendment
Commissioner for Patents
Washington, D.C. 20231

Dear Sir:

This communication is in response to the Election of Species Restriction Requirement mailed on January 14, 2003, the initial period for response to which expires on February 13, 2003.